

ML-7289/ 3CX100A5

UHF Planar Triode

CW or Pulsed
3 Gc



ELECTRON TUBE SPECIALIST

DESCRIPTION

The ML-7289 is a ruggedized, high-mu, planar triode of ceramic-and-metal construction designed specifically for use in new equipment as an oscillator, amplifier or frequency multiplier, at frequencies up to 2.5 Gc. It is well suited for pulsed operation at frequencies up to 3 Gc.

The ML-7289 can, in most cases, replace a 2C39A or 2C39WA directly without equipment modification. It retains the desirable high-mu, low interelectrode capacitance

and high transconductance characteristics of its predecessors. It is manufactured to exacting dimensional tolerances to insure mechanical uniformity. Improved reliability and minimum variation in electrical characteristics are achieved through extensive and precise electrical testing. The ML-7289 is capable of sustained, reliable operation at elevated temperatures.

GENERAL CHARACTERISTICS

Electrical

Heater Voltage, AC or DC (See Application Notes)	6.0	V
Heater Current at 6.0 Volts	1.0	A
Heater Heating Time, minimum	60	sec
Amplification Factor	100	
Transconductance (ib=70 ma, eb=600 v)	25000	μmhos
Interelectrode Capacitances, without Heater Voltage		
Grid-Plate	2.0	pf
Grid-Cathode	6.30	pf
Plate-Cathode, maximum035	pf

Mechanical

Mounting Position	Optional
Type of Cooling	Forced-Air
Maximum Anode Shank and Envelope Temperature	300 °C
Altitude Rating, CW operation	60000 ft
Net Weight	2.5 oz

MAXIMUM RATINGS AND TYPICAL OPERATING CONDITIONS

**RF Power Amplifier and Oscillator
Class C Telegraphy**

Key-down conditions per tube without amplitude modulation‡

Maximum Ratings, Absolute Values

DC Plate Voltage	1000 V
DC Grid Voltage	-150 V
Instantaneous Peak Grid-Cathode Voltage	
Grid negative to cathode	-400 v
Grid positive to cathode	30 v
DC Cathode Current	125 mA
DC Grid Current§	50 mA
Plate Dissipation, Forced-Air Cooling†	100 W
Grid Dissipation	2 W
Frequency	2.5 Gc
Typical Operation, RF Power Amplifier, Grid Separation Circuit	
Frequency	500 Mc
DC Plate Voltage	900 V
DC Grid Voltage	-40 V
DC Plate Current	90 mA
DC Grid Current, approximate	30 mA
Driving Power, approximate	6 W
Useful Power Output	40 W
Typical Operation, RF Oscillator	
Frequency	2.5 Gc
DC Plate Voltage	900 V
DC Grid Voltage, approximate	-22 V
DC Plate Current	90 mA
DC Grid Current	10 mA
Useful Power Output	17 W

**Plate-Modulated RF Power Amplifier
Class C Telephony**

Carrier conditions per tube for use with a maximum modulation factor of 1.0.

Maximum Ratings, Absolute Values

DC Plate Voltage*	600 V
DC Grid Voltage	-150 V
Instantaneous Peak Grid-Cathode Voltage	
Grid negative to cathode	-400 v
Grid positive to cathode	30 v
DC Cathode Current	100 mA
DC Grid Current§	50 mA
Plate Dissipation, Forced-Air Cooling†	70 W
Grid Dissipation	2 W
Frequency	2.5 Gc

**Grid-Pulsed or Plate-Pulsed RF Oscillator
and Amplifier — Class C**

Maximum Ratings, Absolute Values

Plate Voltage	
Grid-Pulsed, DC	1000 V
Plate-Pulsed, Peak Pulse Supply	3500 v
DC Grid Voltage	-150 V

Instantaneous Peak Grid-Cathode Voltage	
Grid negative to cathode	-750 v
Grid positive to cathode	250 v
Peak Plate Current	3 a
Peak Grid Current	1.8 a
Average Plate Dissipation, Forced-Air Cooling†	100 W
Average Grid Dissipation	2 W
Pulse Duration	3 μs*
Duty Factor0025 •
Frequency	3 Gc
Typical Operation, Plate-Pulsed Oscillator	
Frequency	3 Gc
Filament Voltage	5.8 V
Pulse Length	3 μs
Duty Factor0025
Peak Plate Pulse Supply Voltage	3500 v
Peak Plate Current from Pulse Supply	3 a
Peak Grid Current	1.8 a
Useful Peak Power Output, approximate	1600 w

Pulse Modulator or Pulse Amplifier

Maximum Ratings, Absolute Values

DC Plate Voltage	1000 V
Peak Plate Voltage	1200 v
DC Grid Voltage	-150 V
Instantaneous Peak Grid-Cathode Voltage	
Grid negative to cathode	-750 v
Grid positive to cathode	250 v
DC Plate Current	100 mA
Pulse Cathode Current	4.8 a
Average Plate Dissipation, Forced-Air Cooling†	100 W
Average Grid Dissipation	2 W
Pulse Duration	3 μs*
Duty Factor0025 •

‡Modulation essentially negative may be used if the positive peak of the envelope does not exceed 115 per cent of the carrier conditions.

§See "Application Notes" on "Determination of Proper Grid Drive".

†Refer to "Cooling" in "Application Notes".

*For modulation factors less than 1.0, a higher dc plate voltage may be used if the sum of the peak audio voltage and the dc plate voltage does not exceed 1200 volts.

•For applications requiring longer pulse duration or higher duty factors, consult the Machlett Engineering Department.

**CHARACTERISTIC RANGE VALUES
FOR EQUIPMENT DESIGN**

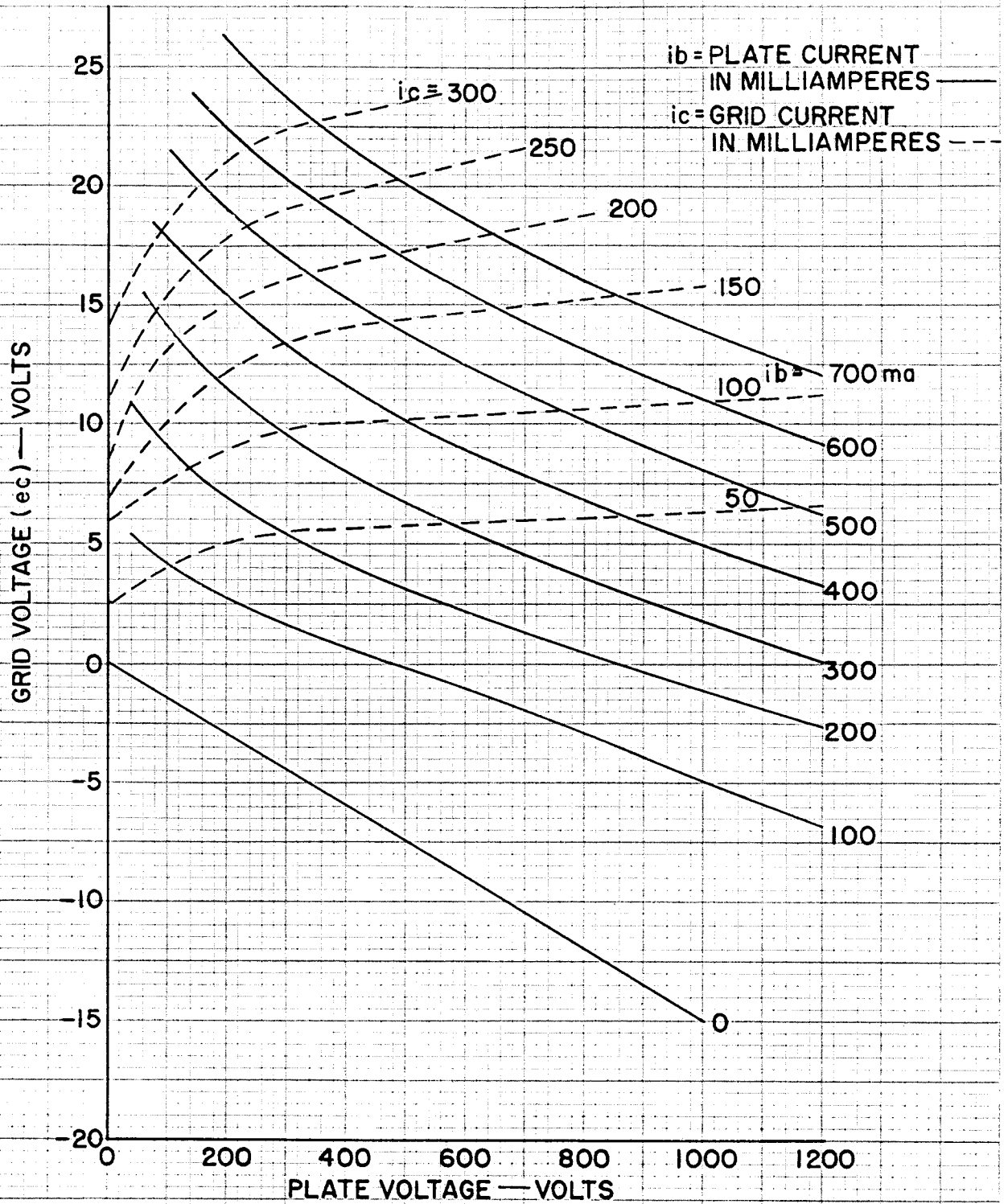
	Min.	Max.	
Filament Current at 6.0 volts90	1.05	A
Cut-off bias (Note 1)	—	-15	V
Grid-Plate Capacitance (Note 2)	1.95	2.15	pf
Grid-Cathode Capacitance (Note 2)	5.60	7.00	pf
Note 1 — Measured at 1 mA of the plate current and a plate voltage of 600 volts.			
Note 2 — Capacitance measurements are with the tube cold.			

APPLICATION NOTES

Before designing equipment for use with these tubes and before installing tubes in equipment, refer to the general information given in the Machlett publication entitled *Application Notes, UHF Tubes — General*.

CONSTANT CURRENT CHARACTERISTICS

$E_f = 6.0V$



CONSTANT GRID-VOLTAGE CHARACTERISTICS

$E_f = 6.0V$

$e_c =$ GRID VOLTAGE IN VOLTS

$e_c = 30V$ 28 26 24

PLATE CURRENT (i_b)

GRID CURRENT (i_c)

CURRENT — MILLIAMPERES

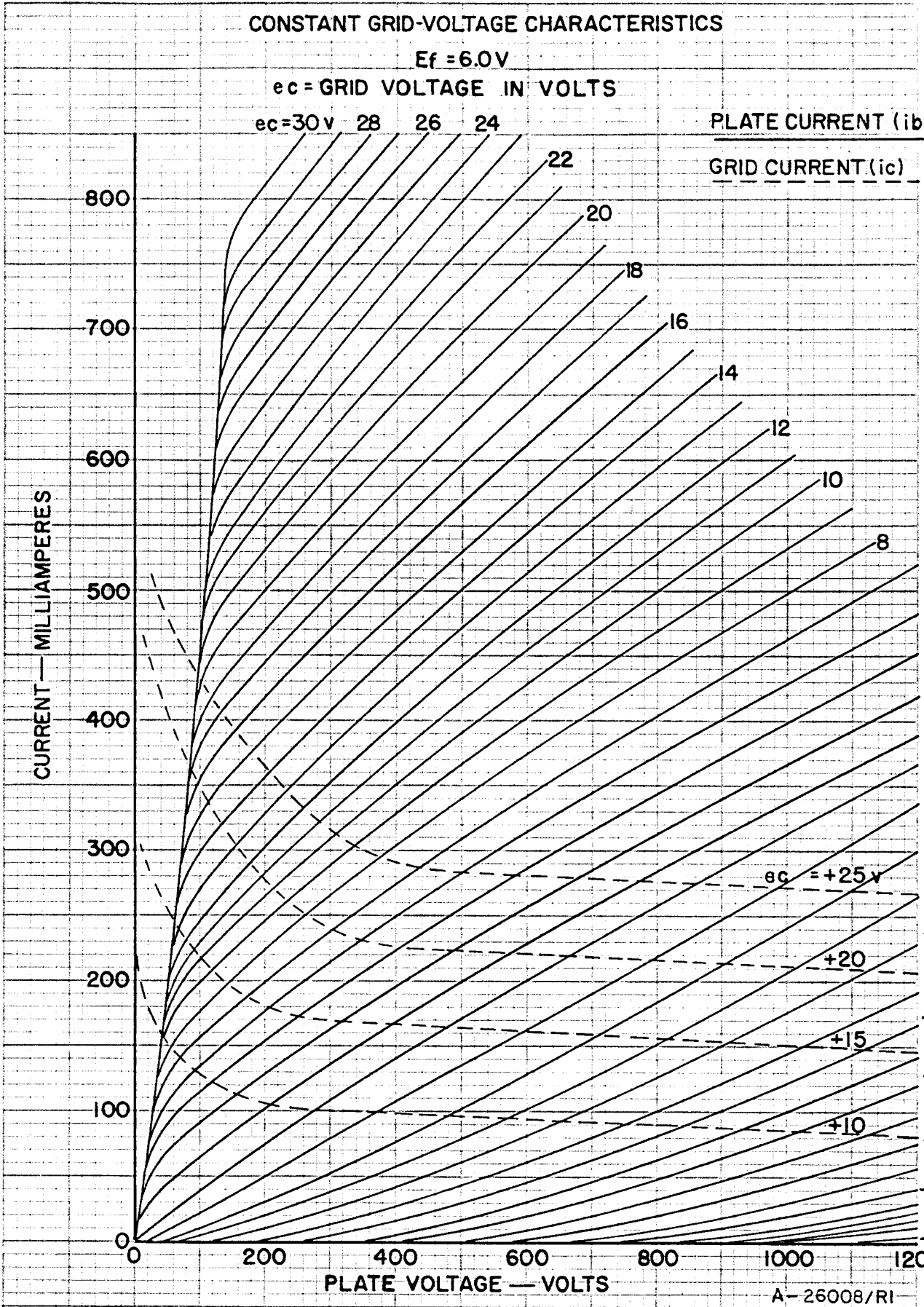
800
700
600
500
400
300
200
100
0

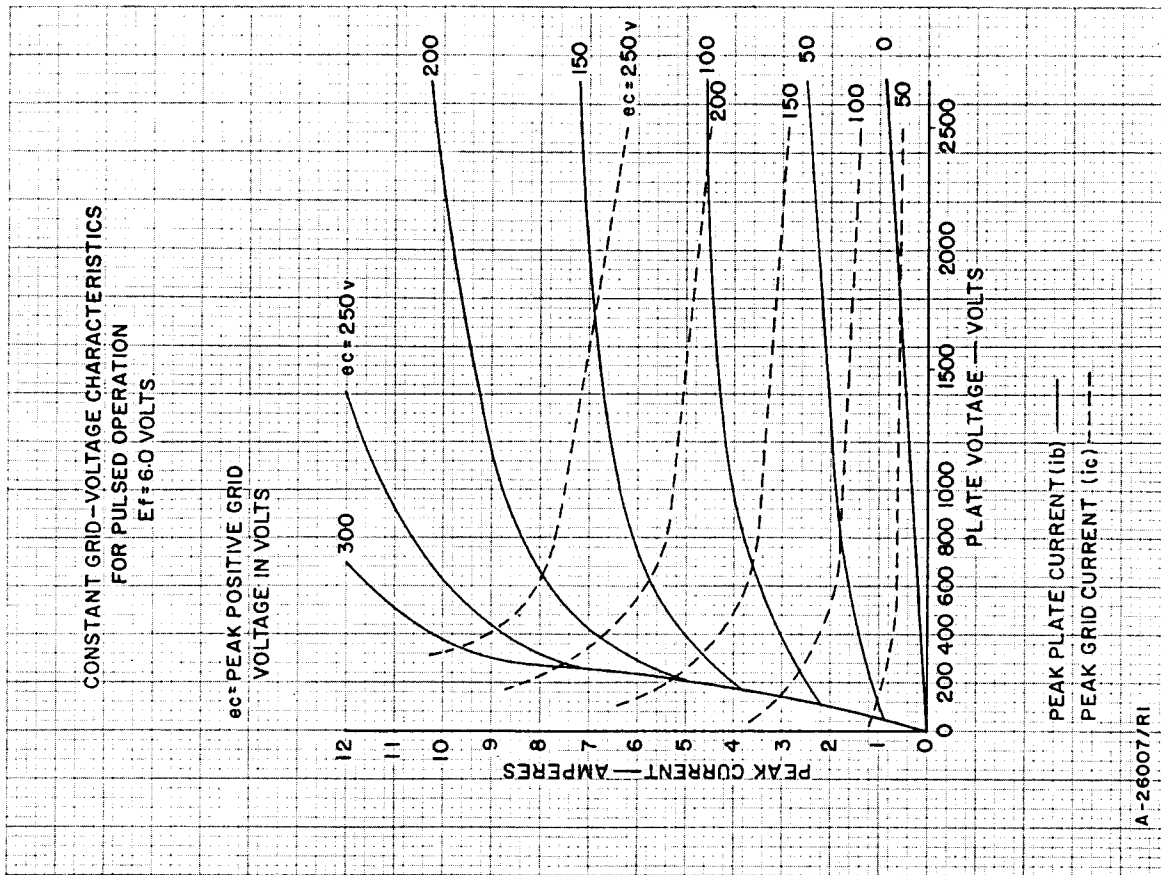
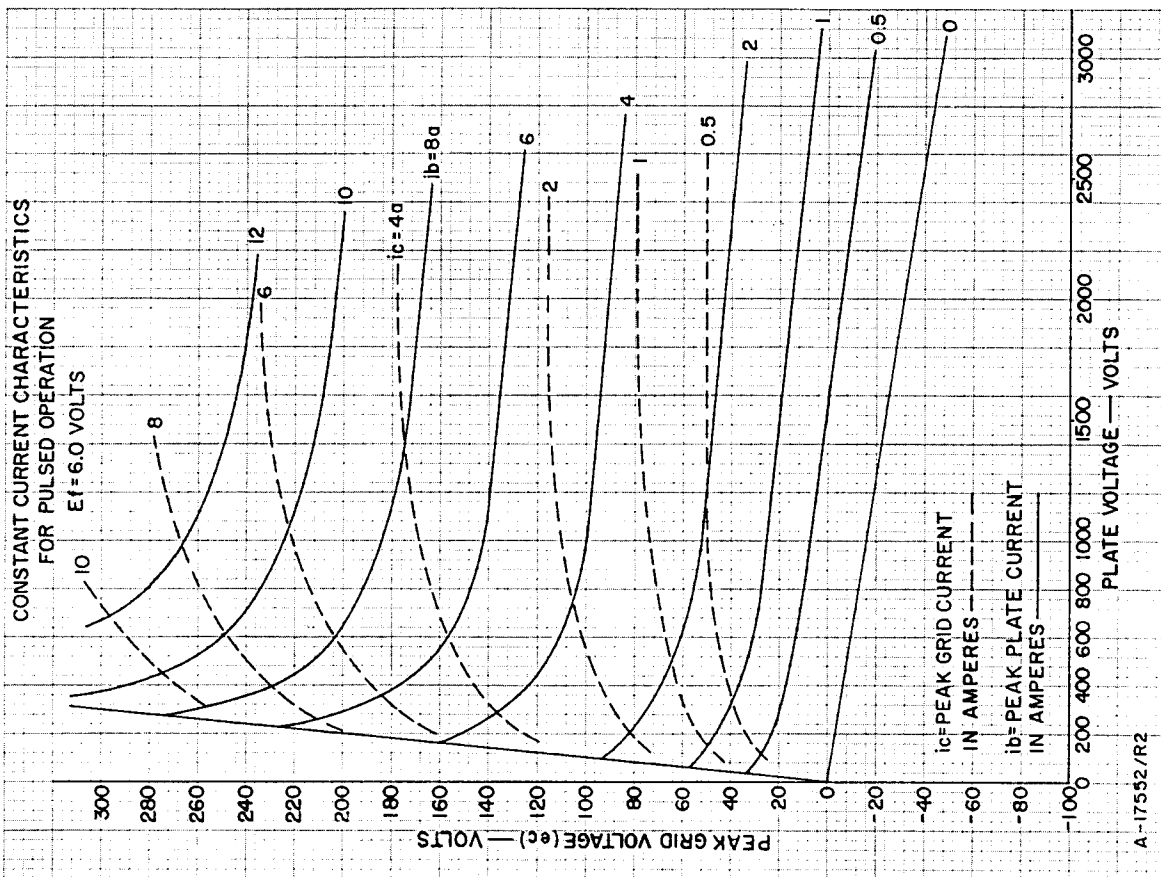
PLATE VOLTAGE — VOLTS

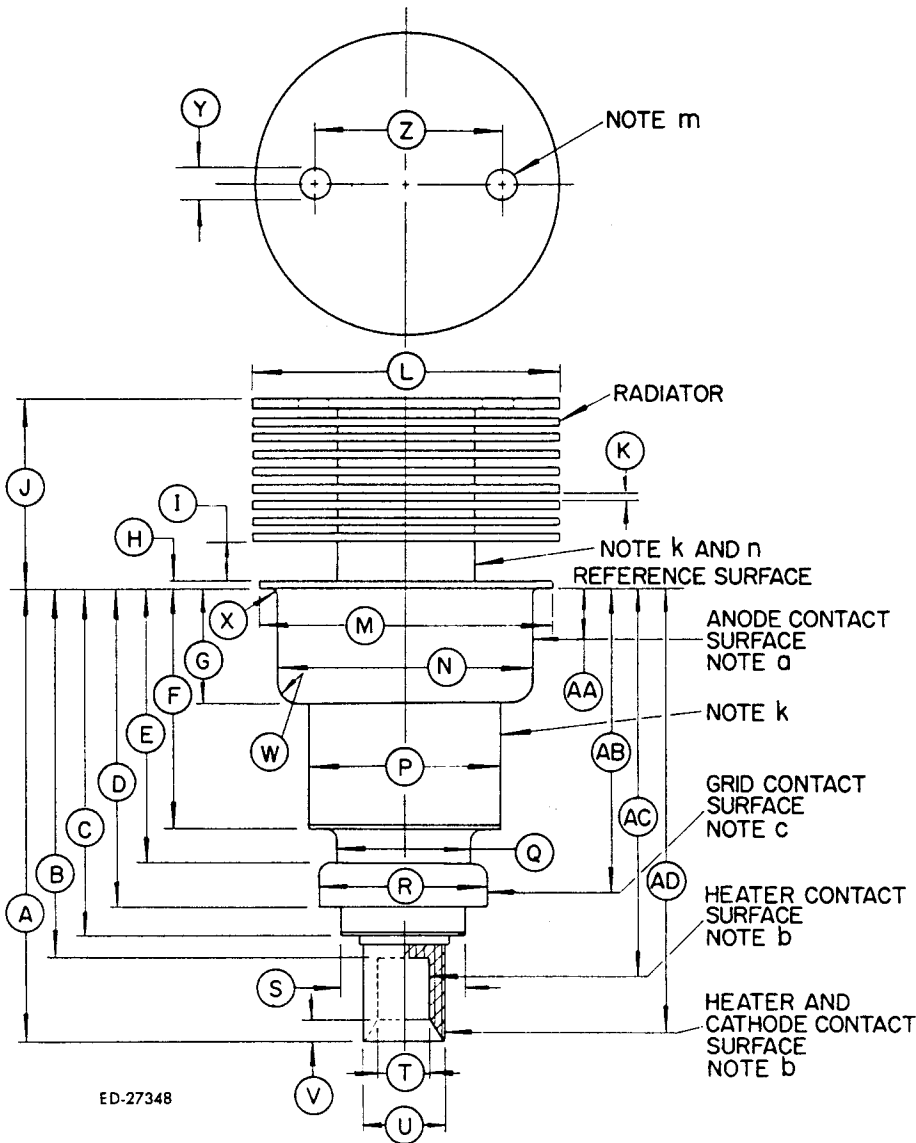
0 200 400 600 800 1000 1200

6
4
2
0
-2
-4
-6
-8
-10
-15

$e_c = +25V$
+20
+15
+10







DIMENSIONS FOR
OUTLINE (INCHES)

Ref.	Minimum	Maximum
A	1.815	1.875
B	—	1.534
C	—	1.475
D	1.289	1.329
E	1.085	1.135
F	.880	.920
G	.462	.477
H	—	.040
I	.125	.185
J	.766	.826
K	.025	.046
L	1.234	1.264
M	1.180	1.195
N	1.025	1.035
P	.772	.792
Q	.541	.561
R	.655	.665
S	—	.545
T	.213	.223
U	.315	.325
V	—	.086
W	—	.100
X	—	.035
Y	.105	.145
Z	.650	.850

NOTES

- a. The total indicated runout of the anode contact surface with respect to the cathode contact surfaces will not exceed .020 inch.
- b. The total indicated runout of the cathode contact surface with respect to the heater contact surfaces will not exceed .012 inch.
- c. The total indicated runout of the grid contact surface with respect to the cathode contact surface will not exceed .020 inch.
- k. Do not clamp or locate on this surface.
- m. Hole provided for tube extractor through the top fin only.
- n. Measure anode shank temperature on this surface.

DIMENSIONS FOR ELECTRODE
CONTACT AREA (INCHES)

Ref.	Dimension	Contact
AA	.198 ± .163	Anode
AB	1.225 ± .040	Grid
AC	1.631 ± .097	Heater
AD	1.645 ± .170	Cathode

DIMENSIONS — ML-7289

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